

Electronic Patent Application Fee Transmittal

Application Number:	10594244			
Filing Date:	25-Sep-2006			
Title of Invention:	Process for forming a solder mask, apparatus thereof and process for forming electric-circuit patterned internal dielectric layer			
First Named Inventor/Applicant Name:	Akio Sekimoto			
Filer:	Marvin Jay Spivak/Sachie Fazzone			
Attorney Docket Number:	295770US40X PCT			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Claims in excess of 20	1615	6	52	312
Independent claims in excess of 3	1614	2	220	440
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				752